

## **40V Dual N-Channel Enhancement Mode MOSFET**

Voltage

40 V

Current

57 A

#### **Features**

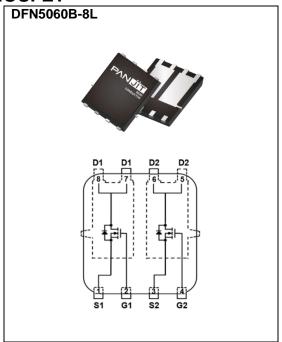
- RDS(ON), VGS@10V, ID@10A<7m $\Omega$
- R<sub>DS(ON)</sub>, V<sub>GS</sub>@7V, I<sub>D</sub>@6A<8.4mΩ
- Excellent FOM
- Standard Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

#### **Mechanical Data**

• Case: DFN5060B-8L Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.092 grams



# **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V <sub>DS</sub>	40	V	
Gate-Source Voltage		V <sub>GS</sub>	±20	v	
Continuous Drain Current(Note 3)	T <sub>C</sub> =25°C		57		
	T <sub>C</sub> =100°C	I <sub>D</sub>	41	Α	
Pulsed Drain Current(Note 1)	T <sub>C</sub> =25°C	I <sub>DM</sub>	228		
Power Dissipation	T <sub>C</sub> =25°C	5	42	107	
	T <sub>C</sub> =100°C	Po	21	W	
Continuous Drain Current(Note 4)	T <sub>A</sub> =25°C		14		
	T <sub>A</sub> =70°C	I <sub>D</sub>	12	A	
Power Dissipation	T <sub>A</sub> =25°C	D-	2.5	107	
	T <sub>A</sub> =70°C	P <sub>D</sub>	1.8	W	
Single Pulse Avalanche Energy <sup>(Note 5)</sup>		Eas	43	mJ	
Operating Junction and Storage Temperature Range		T <sub>J</sub> ,T <sub>STG</sub>	-55~175	°C	
Thermal Resistance <sup>(Note 4)</sup>	Junction to Case	R <sub>0JC</sub>	3.6	°C/W	
	Junction to Ambient	$R_{\theta JA}$	60	C/VV	



### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

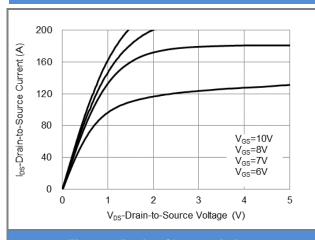
PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	40	-	-	V	
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =50uA	2 2.8 3.5 V		\ \		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =10A	-	5.6	7		
		V <sub>GS</sub> =7V, I <sub>D</sub> =6A	-	6.5	8.4	mΩ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V	-	-	1	uA	
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	-	-	±100	nA	
Dynamic <sup>(Note 6)</sup>	•					•	
Total Gate Charge	$Q_g$	V <sub>DS</sub> =32V, I <sub>D</sub> =10A, V <sub>GS</sub> =10V	ı	23	31	nC	
Gate-Source Charge	Qgs		-	5	-		
Gate-Drain Charge	$Q_{gd}$		-	6	-		
Input Capacitance	Ciss	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1MHz	-	1283	1668	pF	
Output Capacitance	Coss		-	252	378		
Reverse Transfer Capacitance	Crss		-	46	80		
Gate resistance	Rg	f=1MHz	-	0.8	-	Ω	
Turn-On Delay Time	td <sub>(on)</sub>	V <sub>DS</sub> =32V, I <sub>D</sub> =10A, V <sub>GS</sub> =10V, R <sub>G</sub> =3Ω	-	14	-	ns	
Turn-On Rise Time	tr		-	3	-		
Turn-Off Delay Time	td <sub>(off)</sub>		-	24	-		
Turn-Off Fall Time	tf	(Note 2)	-	5	-		
Drain-Source Diode	-				•		
Diode Forward Current	Is	T 0-90	-	-	57	A	
Pulsed Diode Forward Current	I <sub>SM</sub>	T <sub>C</sub> =25°C	-	-	228		
Diode Forward Voltage	$V_{SD}$	Is=20A, V <sub>GS</sub> =0V	-	0.86	1.3	V	
Reverse Recovery Time	Trr	V <sub>DD</sub> =20V,V <sub>GS</sub> =0V	-	24	-	ns	
Reverse Recovery Charge	Qrr	I <sub>S</sub> =20A,dI <sub>S</sub> /dt=100A/us	-	11	-	nC	

#### NOTES:

- 1. Pulse width<100us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Chip capability with an  $R_{\theta JC}=3.6^{\circ}C/W$ .
- 4. R<sub>BJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch<sup>2</sup> with 2oz.square pad of copper.
- 5. The test condition is L=0.5mH, I<sub>AS</sub>=13A, V<sub>DD</sub>=30V, V<sub>GS</sub>=10V, Starting T<sub>J</sub>=25°C. the chip is about to carry I<sub>AS</sub>≈26A.
- 6. Guaranteed by design, not subject to production testing.



#### **TYPICAL CHARACTERISTIC CURVES**



**Fig.1 On-Region Characteristics** 

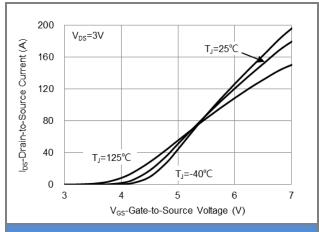


Fig.2 Transfer Characteristics

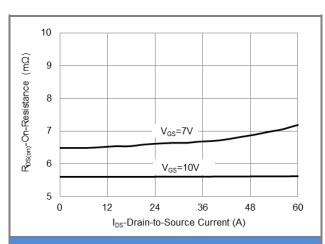


Fig.3 On-Resistance vs. Drain Current

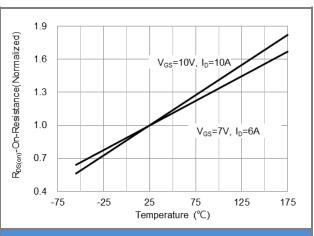
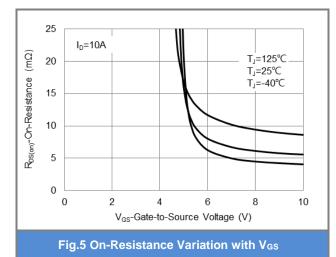


Fig.4 On-Resistance vs. Junction temperature



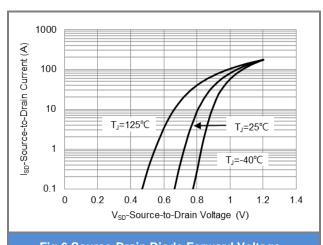


Fig.6 Source-Drain Diode Forward Voltage



#### **TYPICAL CHARACTERISTIC CURVES**

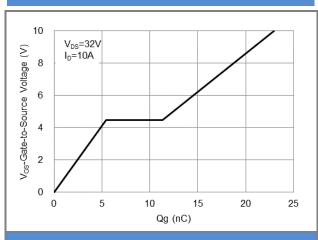


Fig.7 Gate-Charge Characteristics

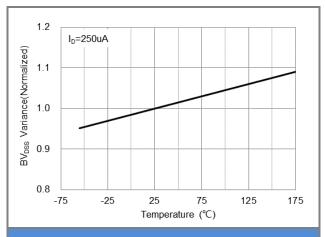


Fig.8 Breakdown Voltage Variation vs. Temperature

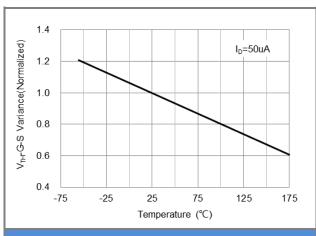


Fig.9 Threshold Voltage Variation with Temperature

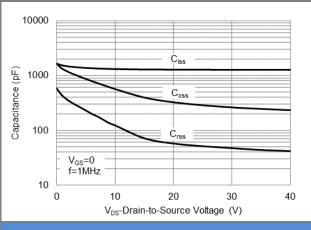


Fig.10 Capacitance vs. Drain-Source Voltage

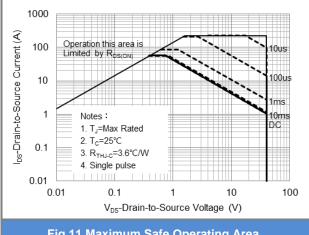


Fig.11 Maximum Safe Operating Area

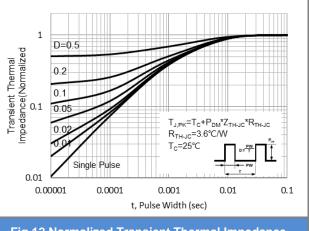


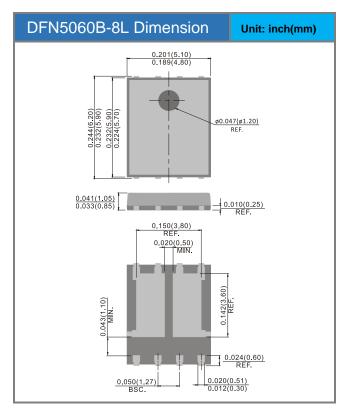
Fig.12 Normalized Transient Thermal Impedance

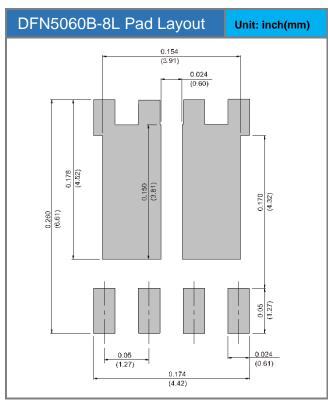


# **Product and Packing Information**

Part No.	Package Type	Packing Type	Marking	
PJQ5946V-AU	DFN5060B-8L	3K pcs / 13" reel	Q5946V	

# **Packaging Information & Mounting Pad Layout**







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